

**TUV Rheinland of North America, Inc.** 

295 Foster Street, Suite 100, Littleton, MA 01460

Hereby certifies that:

### Micron Technology, Inc.

#### 8000 South Federal Way **Boise, ID 83707** USA

has established and maintains an environmental management system for the

#### Design, Research and Development, Manufacture, Assembly and Test of Memory Components, Module and SSD Products

An audit was performed and documented in Report No. 3516. Proof has been furnished that the requirements according to

ISO 14001:2015

are fulfilled.

Further clarification regarding the scope of this certificate and the applicability of ISO 14001:2015 requirements may be obtained by contacting TRNA.

Certificate Registration No.

74 300 3516

Certificate Issue Date **January 16, 2022**  Certificate Expiration Date **January 15, 2025** 





Reissue Date: 01/14/2022



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Precisely Right.

This appendix lists the sites certified under Certificate Number

**74 300 3516**, valid until **January 15, 2025** 

for

### Micron Technology, Inc.

Certificate No. 74 300 3516	Site Name	Site Address	Site Scope of Certification	Activities/Processes (Site Specific)
/00	Central Function	Micron Technology, Inc. Global EHS Post Office Box 6 8000 South Federal Way Boise, ID 83707-0006 USA	Design, Research and Development, Manufacture, Assembly and Test of Memory Components, Module and SSD Products	Central Function - manages activities of the global multisite management system
/01	(MTI)	Micron Technology, Inc. 8000 South Federal Way Boise, ID 83707 USA	Design, Research and Development of Semiconductor Memory Components	Design, research and development, internal warehousing
/02	Fab 6 (MTV)	Micron Technology, Inc. 9600 Godwin Drive Manassas, VA 20110 USA	Manufacturing and Testing of Semiconductor Wafers	Wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, chemical vapor deposition, chemical mechanical planarization) and testing (probe)

This appendix is only valid in conjunction with the referenced certificate.

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Certificate No. 74 300 3516	Site Name	Site Address	Site Scope of Certification	Activities/Processes (Site Specific)
/04	MSB	Micron Semiconductor Asia Operations Pte. Ltd. 990 Bendemeer Road 339942 Singapore	Manufacturing and Testing of Memory Component, Module and SSD products for Semiconductors	Back-end manufacturing, wafer thinning, wafer saw, wire bond, encapsulation, burn-in, test operations, module and SSD assembly and package assembly, internal warehousing and logistics
/05	MXA	Micron Semiconductor (Xi'an) Co., Ltd. No. 28-2, Xin Xi Avenue, High-tech Industries Development Zone, Xi'an, 710119 Shaanxi, P.R. China	Manufacturing and Testing of Semiconductor Components and Module Products	Back-end manufacturing, test floor, burn-in, post electrical, module assembly and package assembly, die recovery, internal and external warehousing, logistics
/06	MMY	Micron Semiconductor Malaysia Sdn. Bhd. No K1-5, PLO 107 (PTD 6571), Tanjung Agas Industrial Area, 84007 Muar, Johor, Malaysia	Manufacturing and Testing of Semiconductor Components	Back-end manufacturing, wafer thinning, wafer saw, wire bond, encapsulation, test operations, die attach, post encapsulation, warehousing and logistics

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Certificate No. 74 300 3516	Site Name	Site Address	Site Scope of Certification	Activities/Processes (Site Specific)
/07	Fab 10W	Micron Semiconductor Asia Operations Pte. Ltd. 1 Woodlands Industrial Park D, Street 1 738799 Singapore	Manufacturing and Testing of Semiconductor Wafers	Wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, thin film, chemical mechanical planarization), testing (probe) and internal warehousing
/08	Fab 10N	Micron Semiconductor Asia Operations Pte. Ltd. 1 Northcoast Drive 757432 Singapore	Research and Development, Manufacturing and Testing of Semiconductor Wafers	Research and development, wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, thin film, chemical mechanical planarization), testing (probe) and internal warehousing]

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Certificate No. 74 300 3516	Site Name	Site Address	Site Scope of Certification	Activities/Processes (Site Specific)
/09	Fab 16 (MMT)	Micron Memory Taiwan Co., Ltd. No. 369, Sec 4 Sanfong Road Houli District Taichung City 42152, Taiwan	Manufacturing and Testing of Semiconductor Wafers	Wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, chemical vapor deposition, chemical mechanical planarization and wafer probe testing), testing (probe) and internal warehousing
/11	Fab 15 (MMJ)	Micron Memory Japan, K.K. 7-10, Yoshikawa Kogyo Danchi, Higashi Hiroshima-shi Hiroshima 739-0198 Japan	Research and Development, Manufacturing and Testing of Semiconductor Wafers	Research and development, wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, thin film, chemical mechanical planarization), testing (probe) and internal warehousing

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Certificate No. 74 300 3516	Site Name	Site Address	Site Scope of Certification	Activities/Processes (Site Specific)
/12	Fab 11 (MTTW)	Micron Technology Taiwan, Inc. No. 667, Fuhsing 3rd Road Hwa-Ya Technology Park Guishan District Taoyuan, 333 Taiwan	Manufacturing and Testing of Semiconductor Wafers	Wafer fabrication (diffusion, ion implantation, photolithography, wet process, dry etch, chemical vapor deposition, chemical mechanical planarization and wafer probe testing), testing (probe) and internal warehousing
/13	МТВ	Micron Memory Taiwan Co., Ltd. No. 88, No. 88-1, Houke S. Rd, Houli District Taichung City 42152 Taiwan	Manufacturing and Testing of Semiconductor Module Products	Back-end manufacturing, wafer thinning, wafer saw, wire bond, encapsulation, burn-in, test operations, internal warehousing and logistics
/15	MNG	Micron Memory Malaysia Sdn. Bhd. No. 1063, Plot 19, Tingkat Perusahaan 6, Prai Industrial Estate, 13600 Prai, Penang Malaysia	Manufacturing and Testing of Semiconductor Module and SSD Products	Back-end manufacturing, test operations, module and SSD assembly, internal warehousing and logistics

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/16	ММР	Micron Memory Malaysia Sdn. Bhd. PMT 779, Lingkaran Cassia Selatan Taman Perindustrian Batu Kawan 14110 Bandar Cassia Mukim 13, Seberang Perai Selatan, Penang, Malaysia	Manufacturing and Testing of Semiconductor Module, SSD Products and Component Assembly	Back-end manufacturing, wafer thinning, wafer saw, wire bond, encapsulation, burn-in, test operations, module and SSD assembly, internal warehousing and logistics)
/17	MMY (external warehouse)	Micron Semiconductor Malaysia Sdn. Bhd. External Warehouse (Golden Sands II) K93 (PLO 74), Jalan Perindustrian 7 Tanjung Agas Industrial Area 84007 Tangkak, Johor Malaysia	Manufacturing and Testing of Semiconductor Components	External warehousing, logistics

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